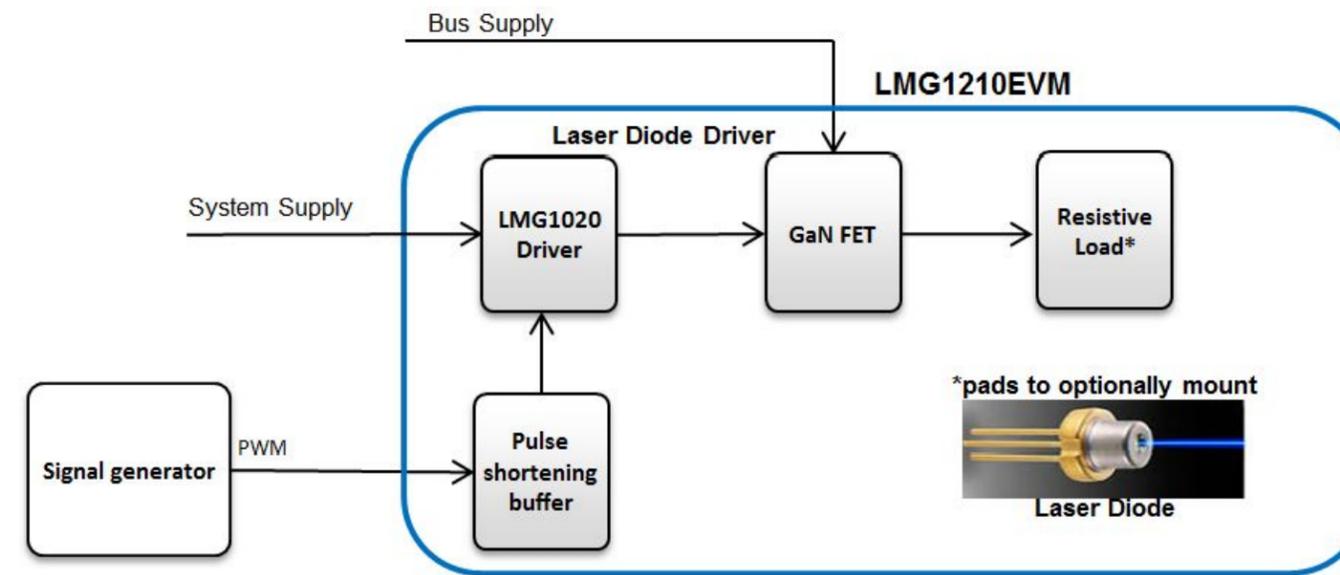


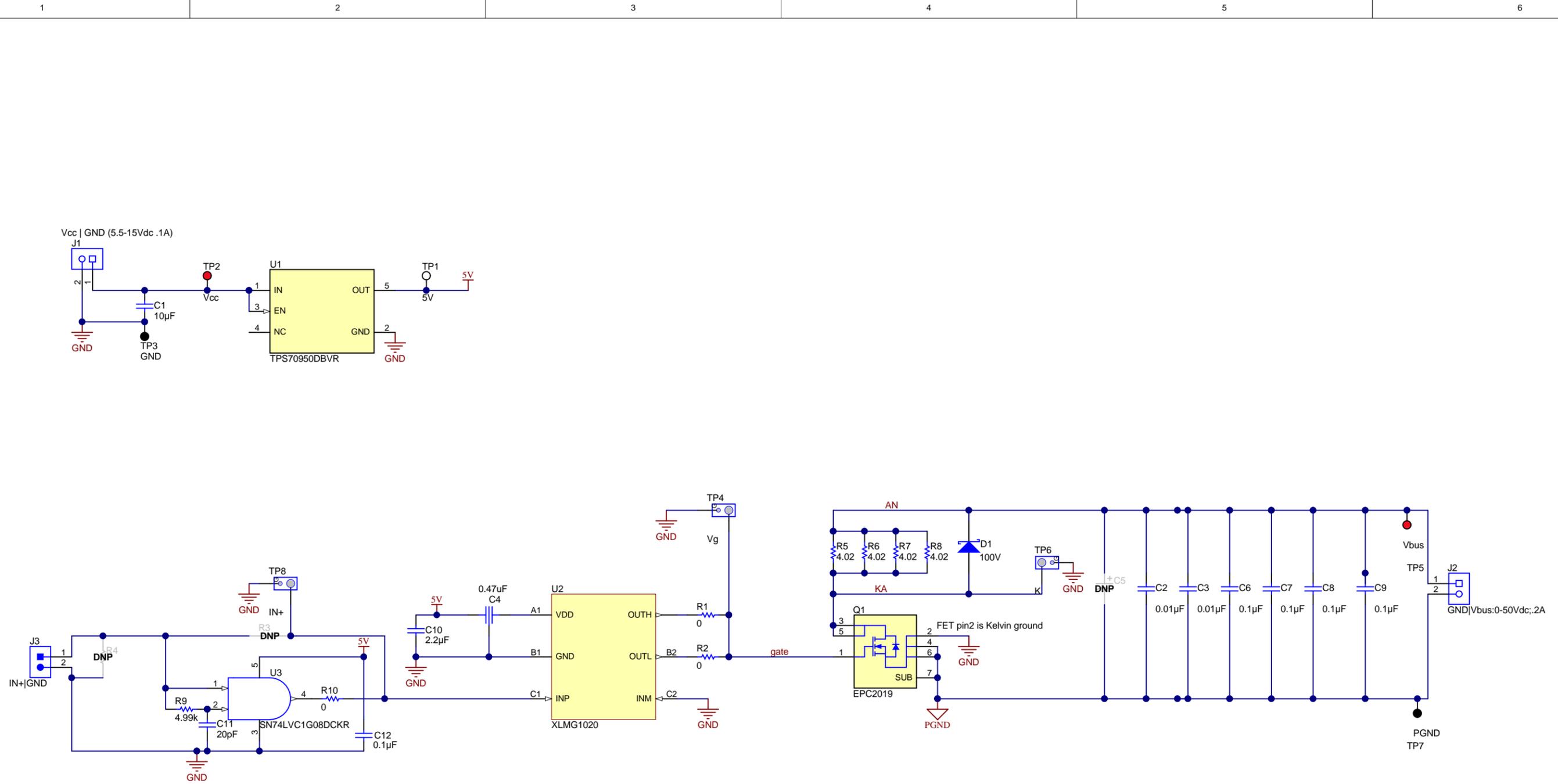
Revision History

Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A



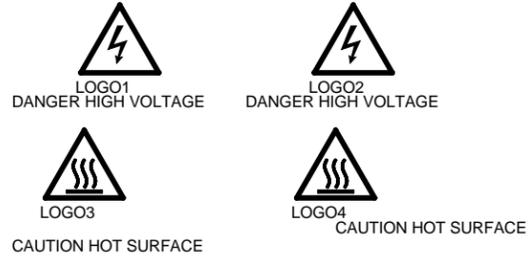
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TID #: TIDA-01573	Project Title: Nanosecond High-Intensity Laser Driver Stage Refe	Sheet: 1 of 3	
Number: TIDA-01573	Rev: A	Sheet Title:	<a href="http://www.ti.com">http://www.ti.com</a>
SVN Rev: Version control disabled	Assembly Variant: 001	Size: B	
Drawn By:	File: TIDA-01573_CoverSheet.SchDoc	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	
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TID #: TIDA-01573	Project Title: Nanosecond High-Intensity Laser Driver Stage Reference Design		
Number: TIDA-01573	Rev: A	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3	
Drawn By:	File: TIDA-01573.SchDoc	Size: B	
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PCB Rev: A  
IPC1 Printed Circuit Board



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TID #: TIDA-01573	Project Title: Nanosecond High-Intensity Laser Driver Stage Refe		
Number: TIDA-01573	Rev: A	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 3 of 3	
Drawn By:	File: TIDA-01573_EVM_Hardware.SchDoc	Size: B	
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